PCN Num		ımber:	20160921001			PCI	N D	ate:	Sept. 27 2016
Title: Datasheet fo			r UCC27321-Q1/UCC27322-Q1						
Customer Contact:		ner Contact:	PCN Manager				Dept:		Quality Services
Ch	ange	е Туре:							
	Ass	sembly Site			Design			Wafe	er Bump Site
	Assembly Process		□ Data Sheet				Wafer Bump Material		
Assembly Materials			Part number change Wafe			er Bump Process			
Mechanical Specification								er Fab Site	
Packing/Shipping/Labeling				Test Process		Wafe	er Fab Materials		
								Wafe	er Fab Process
				N	otification Details	S			
		otion of Chang							
Texas Instruments Incorporated is announcing an information only notification.									
The product datasheet(s) is updated as seen in the change revision history below:									
									TEXAS
TEXAS INSTRUMENTS									INSTRUMENTS
UCC27321-Q1, UCC27322-Q1									4:
SLU	SLUSA13D – FEBRUARY 2010 – REVISED SEPTEMBER 2016 www.ti.com							www.ti.com	
Changes from Revision C (January 2012) to Revision D									
Added Device Information table, ESD Ratings table, Feature Description section, Device Functional Modes,									
	Application and Implementation section, Power Supply Recommendations section, Layout section, Device and								
	Documentation Support section, and Mechanical, Packaging, and Orderable Information section								
•	Changed UCC3732x to UCC2732x-Q1 throughout document								
•	Deleted Ordering Information table; see POA added at the end of the data sheet								
•	Changed table descriptions for AGND and PGND								
•	Updated values in the <i>Thermal Information</i> table to align with JEDEC standards								
•	Changed x-axis values from 1, 10, 100 to 0.1, 1, 10 in Rise Time vs Load Capacitance graph								
<u>. </u>	Delete	ed note reference [1]							12
					1				
		Family						From:	Change To:
UCC27321-Q1/UCC27322-Q1							3C	SLUSA13D	
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/lit/ds/symlink/ucc27321-q1.pdf									
Re	easor	for Change:							
То	more	e accurately ref	lect device cl	nara	acteristics.				
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes									
to the actual device.									
Ch	ange	es to product	identificatio	n r	esulting from this P	CN:			
	ne.	•							
		t Affactad							
_		t Affected:			1000700000			00===	200001
		'321QDRQ1			UCC27322QDGNRQ1				2QDRQ1
	For questions regarding this notice, e-mails can be sent to the regional contacts shown below								
٥r	or your local Field Sales Representative.								

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com